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INFORMATION DISCLOSURE STATEMENT BY APPLICANT ( Not for submission under 37 CFR 1.99)

Application Number		10531763
Filing Date		2005-04-18
First Named Inventor	Susar	n D. Strothers
Art Unit		Unknow
Examiner Name	Unkn	own
Attorney Docket Number		H0004599.69957 US -4015

	U.S.PATENTS									
Examiner Initial*	r Cite No Patent Number		Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear				
	1	6689254	B1	2004-02-10	Tokyo Electron Limited	Claims 1, 2, 15, 17, 19, 27, 32, 41				
	2	5409590	A	1995-04-25	Tokyo Electron Limited	Claims 1 and 3				
	3	5130005	A	1992-07-14	Tokyo Electron Limited	Claims 1, 6, 11, 15, 18, 21				
	4	6340415	B1	2002-01-22	Applied Materials, Inc.	Claim 1, 21, 26, 28				
	5	6955852	B2	2005-10-18	Tosoh SMD, Inc.	Claims 1, 2, 3				
	6	6840427	B2	2005-01-11	Tosoh SMD, Inc.	Claims 1 and 14				
	7	5487822	A	1996-01-30	Applied Materials, Inc.	All Claims				
	8	5565071	A	1996-10-15	Applied Materials, Inc.	Claim, 1 and 9				

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 Examiner Name
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	9	5595337	A	1997-01	-21	Applied Materi	als, Inc.	Claim	s 1, 2, 3	
	10	5603816	A	1997-02-18		Applied Materials, Inc.		Claim 1		
	11	5433835	A	1995-07-18		Applied Materials, Inc.		Claims 1, 14, 21		
	12	5676803	А	1997-10-14		Applied Komatus Technology, Inc.		Claims 1, 7, 10, 11		
	13	5863397	А	1999-01-26		Taiwan Semiconductor Manufacturing Co. Ltd.		Claims 1, 5, 15		
	14	5985115	A	1999-11-16		Novellus Systems, Inc.		Claims 1-4, 5-8		
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( Not for submission under 37 CFK 1.99)	Examiner Name	Unkno	nown	
	Attorney Docket Number		H0004599.69957 US -4015	

	1	10018858	DE		2001-10-25	Ardenne Anlagentech GmbH	Claim 1		
	2	01-132761	JP		1989-05-25	Fujitsu Ltd.			
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